

## LCGT Goal





"Detecting GW a few times per year"

 (1) NS-NS binary inspirals SN=8@190Mpc; ~1 event per year SN=8@240~270Mpc; 2-3 events per year (Duty cycle=90%, detection probability=90%)

 (2) Cooling mirrors to 20K and circulating 400kW light in 3km arms, we can realize the sensitivity.



#### IFO Design

## **Detector Configuration Group**

1. Design the detector according to the noise analysis

2. Set requirements to realize the sensitivity

3. Risk management







Thermal conductivity of Sapphire fiber

 Use Sapphire substrate that is good with 1064nm laser, has high thermal conductivity, and has high Q

(2) 20K fiber can transfer ~1W heat

(3) Absorption of Sapphire substrate is not small



High-finesse RSE (F=1550)

- 825W in PRC, Arm power=400kW
- Absorption in ITM substrate=0.24W
  Absorption in coatings=0.20W
- Fiber diameter=1.6mm, length=30cm

### <u>RSE</u>

#### **RSE=Resonant Sideband Extraction**



Same shot-noise level but different power in ITMs



## DC readout



#### RF readout to DC readout

- 10% better shot noise
- lower laser noise
- almost no RF noise
- simpler OMC
- simpler PD

Adding offset to the arms and use the leaking DC light as reference

DC readout lets us use QND technique to reduce quantum noise

## **BAE and Optical spring**



RP noise can be compensated by optimizing the DC readout phase



BRSE: ITM-SRM RT=(N+1/2) $\lambda$ DRSE: ITM-SRM RT $\neq$ (N+1/2) $\lambda$ 

We can beat the SQL by changing the SRM microscopic location

IR increases by 7% with BAE, and extra 12% with detuning.

## <u>Mirror thermal noise</u>



Coating BR: mirror distortion by thermal energy in the coatings Mirror TE: mirror expansion by temperature fluctuation via thermal expansion Mirror BR: mirror distortion by thermal energy in the substrate Substrate Q=1e8 Ti-Tantala coating  $\phi$ =5e-4 Silica coating  $\phi$ =3e-4 ITM:9 layer, ETM:18 layer

- Mechanical loss of coatings increases at 20K; aLIGO:2e-4/5e-5 \*UK Measurement tells 8e-4/5e-4, but it'll be better by 60% with 600C annealing
- Sapphire Substrate Q of 1e8 is a measured value
- Beam radii are 3.5cm on ITM, and 4.2cm on ETM
  - ~ should be tuned to avoid HOM resonance (g1=-0.87, g2=-0.60)
  - ~ ITM beam size is limited by BS size and property of Kamaboko mirror

## Suspension thermal noise



Values are for TM/IM/RM fiber (test mass/intermediate mass/recoil mass) Material=Sapphire/Tungsten/BeCu Structure loss=5e-8/1e-4/5e-6 Fiber length=30cm/50cm/30cm Fiber d=1.6mm/0.6mm/0.4mm Clamp loss=0/1e-3/0 Temperature=16K/10K/16K Mini GAS freq=0.4Hz HV coupling=1/200 IM/RM mass=60kg/30kg

- Sapphire fiber Q is a measured value
- Fiber length has been reduced to move a violin-mode peak
  \*40cm -> 150Hz, 30cm -> 235Hz
- Vertical resonance at 117Hz is hard to move away;
  thus HV coupling and IM/RM loss requirements are strict

### <u>Quantum noise</u>



- For DRSE,  $\phi$ =86.5 deg,  $\zeta$ =134.2 deg
- For BRSE,  $\zeta$ =119.3 deg
- $\cdot$  The best sensitivity is better with DRSE
- Bandwidth is broader with BRSE
- QN exceeds the SQL at around a certain frequency

## <u>Sensitivity summary</u>



- Inspiral range for NSNS binaries is 273Mpc
- Default configuration is DRSE but compatible with BRSE (IR=245Mpc w/BAE, 232Mpc w/o BAE)
- LCGT goal (220Mpc; 2 events per year) can be achieved even with 10% sensitivity reduction by technical noise

## **Requirements to Subsystems**

Laser: 150W, FN, IN IOO: 60% transmission of TEM00 carrier, MZ noise Mirror: opt loss<45±15ppm, substrate abs<600ppm, coating abs<0.5ppm, the rest has been introduced Suspension: thermal conductivity>0.128/T<sup>2.75</sup>, the rest has been introduced Isolation: seismic noise<(2e-17/f^6.5)[1/rtHz] Vacuum: (TBD) Cleanliness: (TBD) ISC + Electronics: LSC/ASC Loop noise Digital: digital noise

I'll talk about this on Saturday

# Toward the construction (iLCGT)



- FPMI at room temperature
- 3-stage suspension
- 10kg silica mirrors
- Finesse 1550
- IR=74Mpc with 20W
- 1-month observation in 2014

Parameters to be determined on iLCGT construction

- Tunnel tilt
- Vacuum level
- Cleanliness
- Vacuum-chamber location (detune/folding)
- MC design
- BS